

CMOS Digital Integrated Circuits Silicon Monolithic

## TC7WZ74FK

### 1. Functional Description

• D-Type Flip Flop with Preset and Clear

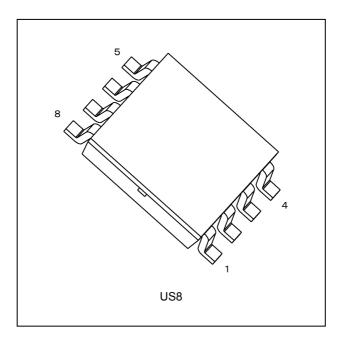
#### 2. Features

- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C (Note 2)
- (3) High output current:  $\pm 24$  mA (min) ( $V_{CC} = 3.0$  V)
- (4) High speed operation:  $t_{pd} = 2.8 \text{ ns (typ.)}$  ( $V_{CC} = 5.0 \text{ V}$ ,  $C_L = 50 \text{ pF}$ )
- (5) Wide operating voltage range:  $V_{CC} = 1.65$  to 5.5 V
- (6) 5.5 V tolerant inputs
- (7) 5.5 V power down protection output
- (8) Matches the performance of TC74LCX series when operated at  $3.3\ V\ V_{CC}$

Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

Note 2: For devices with the ordering part number ending in J(CT. Topr = -40 to 85 °C for the other devices.

#### 3. Packaging

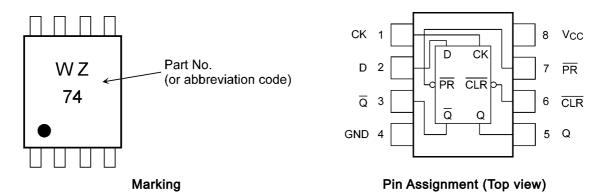


Start of commercial production

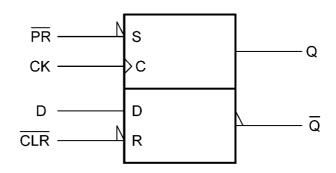
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## 4. Marking and Pin Assignment



5. IEC Logic Symbol



## 6. Truth Table

	Inputs				Out	puts	Function	
CL	R	PR	D	СК	Q	Q	FullClion	
L		Н	Х	Х	L	Н	Clear	
Н		L	Х	Х	Н	L	Preset	
L		L	Х	Х	Н	Н	_	
Н		Н	L		L	Н	_	
Н		Н	Н		Н	L	_	
Н		Н	Х		Qn	Qn	No Change	

X: Don't care



## 7. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 6.0	V
Input voltage	V <sub>IN</sub>		-0.5 to 6.0	V
DC output voltage	V <sub>OUT</sub>	(Note 1)	-0.5 to 6.0	V
		(Note 2)	-0.5 to V <sub>CC</sub> + 0.5	
Input diode current	I <sub>IK</sub>		-20	mA
Output diode current	I <sub>OK</sub>	(Note 3)	-20	
DC output current	I <sub>OUT</sub>		±50	
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±50	mA
Power dissipation	P <sub>D</sub>		200	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:  $V_{CC} = 0 V$ 

Note 2: High (H) or Low (L) state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 3: V<sub>OUT</sub> < GND

### 8. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		_	1.65 to 5.5	V
		(Note 1)		1.5 to 5.5	
Input voltage	V <sub>IN</sub>			0 to 5.5	V
Output voltage	$V_{OUT}$	(Note 2)	_	0 to 5.5	V
		(Note 3)	_	0 to V <sub>CC</sub>	
Operating temperature	$T_{opr}$	(Note 4)		-40 to 125	°C
		(Note 5)	_	-40 to 85	
Input rise and fall time	dt/dv		$V_{CC}$ = 1.8 $\pm$ 0.15 V, 2.5 $\pm$ 0.2 V	0 to 20	ns/V
			$V_{CC}$ = 3.3 ± 0.3 V	0 to 10	
			$V_{CC}$ = 5.0 ± 0.5 V	0 to 5	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 1: Data retention only

Note 2:  $V_{CC} = 0 V$ 

Note 3: High (H) or Low (L) state.

Note 4: For devices with the ordering part number ending in J(CT.

Note 5: For devices except those with the ordering part number ending in J(CT.



### 9. Electrical Characteristics

## 9.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		1.65 to 1.8	V <sub>CC</sub> × 0.75	_	_	V
				2.3 to 5.5	$V_{CC} \times 0.70$	_	_	
Low-level input voltage	V <sub>IL</sub>	_		1.65 to 1.8	_	_	V <sub>CC</sub> × 0.25	V
				2.3 to 5.5	_	_	$V_{CC} \times 0.30$	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IL}$ or $V_{IH}$	$I_{OH}$ = -100 $\mu$ A	1.65	1.55	1.65	_	V
				2.3	2.2	2.3	_	
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I <sub>OH</sub> = -4 mA	1.65	1.29	1.52	_	
			I <sub>OH</sub> = -8 mA	2.3	1.9	2.15	_	
			I <sub>OH</sub> = -16 mA	3.0	2.4	2.8	_	
			I <sub>OH</sub> = -24 mA	3.0	2.3	2.68	_	
			I <sub>OH</sub> = -32 mA	4.5	3.8	4.2	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	I <sub>OL</sub> = 100 μA	1.65	_	0.0	0.1	V
				2.3	_	0.0	0.1	
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I <sub>OL</sub> = 4 mA	1.65	_	0.08	0.24	
			I <sub>OL</sub> = 8 mA	2.3	_	0.1	0.3	
			I <sub>OL</sub> = 16 mA	3.0	_	0.15	0.4	
			I <sub>OL</sub> = 24 mA	3.0	_	0.22	0.55	
			I <sub>OL</sub> = 32 mA	4.5	_	0.22	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND	•	0 to 5.5	_	_	±1	μА
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 5.5 V		0	_	_	1	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = 5.5 V or GND		1.65 to 5.5	_	_	1	μА



## 9.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_	1.65 to 1.8	V <sub>CC</sub> × 0.75	_	V	
				2.3 to 5.5	V <sub>CC</sub> × 0.70	_	
Low-level input voltage	V <sub>IL</sub>	_		1.65 to 1.8	_	V <sub>CC</sub> × 0.25	V
				2.3 to 5.5	_	$V_{CC} \times 0.30$	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	I <sub>OH</sub> = -100 μA	1.65	1.55	_	V
				2.3	2.2	_	
				3.0	2.9	_	
				4.5	4.4	_	
			I <sub>OH</sub> = -4 mA	1.65	1.29	_	
			I <sub>OH</sub> = -8 mA	2.3	1.9	_	
			I <sub>OH</sub> = -16 mA	3.0	2.4	_	
			I <sub>OH</sub> = -24 mA	3.0	2.3	_	
			I <sub>OH</sub> = -32 mA	4.5	3.8	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	I <sub>OL</sub> = 100 μA	1.65	_	0.1	V
				2.3	_	0.1	
				3.0	_	0.1	
				4.5	_	0.1	
			I <sub>OL</sub> = 4 mA	1.65	_	0.24	
			I <sub>OL</sub> = 8 mA	2.3	_	0.3	
			I <sub>OL</sub> = 16 mA	3.0	_	0.4	
			I <sub>OL</sub> = 24 mA	3.0	_	0.55	
			I <sub>OL</sub> = 32 mA	4.5	_	0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND	•	0 to 5.5	_	±10	μА
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 5.5 V		0	_	10	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = 5.5 V or GND		1.65 to 5.5	_	10	μА



## 9.3. DC Characteristics (Note) (Unless otherwise specified, $T_a$ = -40 to 125 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	$V_{IH}$	_	1.65 to 1.8	$V_{CC} \times 0.75$	_	V	
				2.3 to 5.5	$V_{CC} \times 0.70$	_	
Low-level input voltage	V <sub>IL</sub>	_		1.65 to 1.8	_	V <sub>CC</sub> × 0.25	V
				2.3 to 5.5		$V_{CC} \times 0.30$	
High-level output voltage	$V_{OH}$	$V_{IN} = V_{IL}$ or $V_{IH}$	I <sub>OH</sub> = -100 μA	1.65	1.55	_	V
				2.3	2.2	_	
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	1.65	0.95	_	
			I <sub>OH</sub> = -8 mA	2.3	1.7	_	
			I <sub>OH</sub> = -16 mA	3.0	2.2	_	
			I <sub>OH</sub> = -24 mA	3.0	2.0	_	
			I <sub>OH</sub> = -32 mA	4.5	3.4	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>	I <sub>OL</sub> = 100 μA	1.65		0.1	V
				2.3		0.1	
				3.0	_	0.1	
				4.5		0.1	
			I <sub>OL</sub> = 4 mA	1.65		0.7	
			I <sub>OL</sub> = 8 mA	2.3	ı	0.45	
			I <sub>OL</sub> = 16 mA	3.0		0.6	
			I <sub>OL</sub> = 24 mA	3.0		0.8	
			I <sub>OL</sub> = 32 mA	4.5		0.8	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5		±20	μΑ
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 5.5 V		0		100	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = 5.5 V or GND		1.65 to 5.5	_	100	μА

Note: For devices with the ordering part number ending in J(CT.



## 9.4. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Unit
Maximum clock frequency	f <sub>MAX</sub>		R <sub>L</sub> = 500 Ω	$1.8 \pm 0.15$	50	51	_	_	MHz
				2.5 ± 0.2		130	_	_	
				$3.3 \pm 0.3$		200	_	_	
				5.0 ± 0.5		200	_	_	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		$R_L = 1 M\Omega$	$1.8 \pm 0.15$	15	2.5	10.0	18.0	ns
(CK-Q,Q)				2.5 ± 0.2		2.0	4.9	7.5	
				$3.3 \pm 0.3$		1.5	3.3	4.8	
				5.0 ± 0.5		1.0	2.4	3.5	
			R <sub>L</sub> = 500 Ω	$3.3 \pm 0.3$	50	2.0	4.3	5.7	
				5.0 ± 0.5		1.5	2.8	4.0	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		$R_L = 1 M\Omega$	$1.8 \pm 0.15$	15	2.5	10.0	17.0	ns
(CLR,PR-Q,Q)				2.5 ± 0.2		2.0	5.0	7.3	
				$3.3 \pm 0.3$		1.5	3.4	4.8	
				5.0 ± 0.5		1.5	2.2	3.5	
			R <sub>L</sub> = 500 Ω	$3.3\pm0.3$	50	2.0	4.3	5.7	
				5.0 ± 0.5		1.0	3.1	3.9	
Minimum setup time	t <sub>s</sub>		R <sub>L</sub> = 500 Ω	2.5 ± 0.2	50	3.4	_	_	ns
				$3.3 \pm 0.3$		2.1	_	_	
				$5.0 \pm 0.5$		1.5	_	_	
Minimum hold time	t <sub>h</sub>		R <sub>L</sub> = 500 Ω	$2.5\pm0.2$	50	2.4			ns
				$3.3\pm0.3$		1.4		_	
				$5.0 \pm 0.5$		1.0			
Minimum pulse width (CK)	$t_{W(L)}, t_{W(H)}$		R <sub>L</sub> = 500 Ω	$2.5\pm0.2$	50	3.0			ns
				$3.3\pm0.3$		3.0		_	
				5.0 ± 0.5		3.0	_	_	
Minimum pulse width	t <sub>W(L)</sub>		R <sub>L</sub> = 500 Ω	$2.5 \pm 0.2$	50	3.0		_	ns
(CLR,PR)				$3.3\pm0.3$		3.0		_	
				5.0 ± 0.5		3.0	_	_	
Minimum removal time	t <sub>rem</sub>		R <sub>L</sub> = 500 Ω	$2.5 \pm 0.2$	50	3.6	_	_	ns
				$3.3\pm0.3$		2.2	_	_	
				$5.0 \pm 0.5$		1.3		_	
Input capacitance	C <sub>IN</sub>		_	0 to 5.5			3.0	10	pF
Output capacitance	C <sub>OUT</sub>		_	0 to 5.5		_	5.0	_	pF
Power dissipation	C <sub>PD</sub>	(Note 1)	_	3.3	_		30	_	pF
capacitance				5.5		_	47	_	

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 



## 9.5. AC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C, Input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Maximum clock frequency	f <sub>MAX</sub>	RL = 500 Ω	1.8 ± 0.15	50	38	_	MHz
			$2.5 \pm 0.2$		100	_	
			$3.3 \pm 0.3$		150	_	
			$5.0 \pm 0.5$		180	_	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	RL = 1 MΩ	1.8 ± 0.15	15	2.1	23.0	ns
$(CK-Q,\overline{Q})$			$2.5 \pm 0.2$		1.7	9.0	
			$3.3\pm0.3$		1.3	5.6	
			$5.0 \pm 0.5$		1.0	3.9	
		RL = 500 Ω	$3.3 \pm 0.3$	50	1.5	7.0	
			$5.0 \pm 0.5$		1.3	4.4	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	RL = 1 M $\Omega$	1.8 ± 0.15	15	2.1	21.0	ns
$(\overline{CLR},\overline{PR}-Q,\overline{Q})$			$2.5 \pm 0.2$		1.7	8.8	
			$3.3 \pm 0.3$		1.3	5.6	
			$5.0 \pm 0.5$		1.0	3.9	
		RL = 500 Ω	$3.3 \pm 0.3$	50	1.5	7.0	
			$5.0 \pm 0.5$		1.0	4.3	
Minimum setup time	t <sub>s</sub>	RL = 500 Ω	$2.5\pm0.2$	50	4.1		ns
			$3.3 \pm 0.3$		2.5	_	
			$5.0 \pm 0.5$		1.7	_	
Minimum hold time	t <sub>h</sub>	RL = 500 Ω	$2.5\pm0.2$	50	2.9	_	ns
			$3.3 \pm 0.3$		1.5	_	
			$5.0 \pm 0.5$		1.1	_	
Minimum pulse width (CK)	$t_{W(L)}, t_{W(H)}$	RL = 500 Ω	$2.5\pm0.2$	50	3.6	_	ns
			$3.3 \pm 0.3$		3.3	_	
			$5.0 \pm 0.5$		3.2	_	
Minimum pulse width	t <sub>W(L)</sub>	RL = 500 Ω	$2.5\pm0.2$	50	3.6		ns
(CLR,PR)			$3.3 \pm 0.3$		3.3	_	
			$5.0 \pm 0.5$		3.2		
Minimum removal time	t <sub>rem</sub>	RL = 500 Ω	$2.5\pm0.2$	50	4.4	_	ns
			$3.3 \pm 0.3$		2.5	_	
			5.0 ± 0.5		1.4	_	



# 9.6. AC Characteristics (Note) (Unless otherwise specified, $T_a$ = -40 to 125 °C, Input: $t_r$ = $t_f$ = 3 ns)

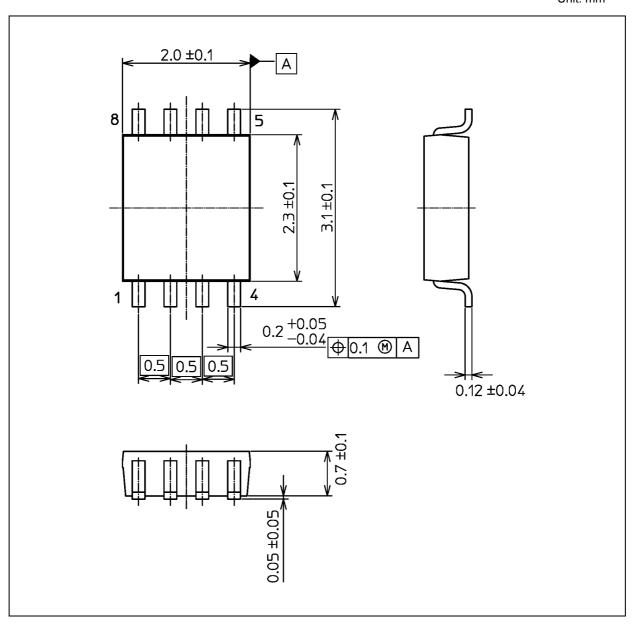
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Maximum clock frequency	f <sub>MAX</sub>	RL = 500 Ω	$1.8 \pm 0.15$	50	34	_	MHz
			$2.5 \pm 0.2$		90	_	
			$3.3 \pm 0.3$		135	_	
			$5.0 \pm 0.5$		162	_	
Propag <u>a</u> tion delay time	$t_{PLH}, t_{PHL}$	RL = 1 M $\Omega$	1.8 ± 0.15	15	2.1	26.0	ns
(CK-Q,Q)			$2.5 \pm 0.2$		1.7	10.0	
			$3.3 \pm 0.3$		1.3	6.2	
			$5.0 \pm 0.5$		1.0	4.3	
		RL = 500 Ω	$3.3 \pm 0.3$	50	1.5	8.8	
			$5.0 \pm 0.5$		1.3	4.9	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	RL = 1 M $\Omega$	1.8 ± 0.15	15	2.1	24.0	ns
$(\overline{CLR},\overline{PR}-Q,\overline{Q})$			$2.5 \pm 0.2$		1.7	9.7	
			$3.3 \pm 0.3$		1.3	6.2	
			5.0 ± 0.5		1.0	4.3	
		RL = 500 Ω	$3.3 \pm 0.3$	50	1.5	7.7	
			$5.0 \pm 0.5$		1.0	4.8	
Minimum setup time	ts	RL = 500 Ω	$2.5 \pm 0.2$	50	4.1	_	ns
			$3.3 \pm 0.3$		2.5	_	
			$5.0 \pm 0.5$		1.7	_	
Minimum hold time	t <sub>h</sub>	RL = 500 Ω	2.5 ± 0.2	50	2.9	_	ns
			$3.3 \pm 0.3$		1.5	_	
			5.0 ± 0.5		1.1	_	
Minimum pulse width (CK)	$t_{W(L)}, t_{W(H)}$	RL = 500 Ω	$2.5\pm0.2$	50	3.6	_	ns
			$3.3 \pm 0.3$		3.3	_	
			5.0 ± 0.5		3.2	_	
Minimum pulse width	t <sub>W(L)</sub>	RL = 500 Ω	2.5 ± 0.2	50	3.6	_	ns
(CLR,PR)			$3.3 \pm 0.3$		3.3	_	
			$5.0 \pm 0.5$		3.2	_	
Minimum removal time	t <sub>rem</sub>	RL = 500 Ω	$2.5 \pm 0.2$	50	4.4	_	ns
			$3.3\pm0.3$		2.5	_	
			$5.0 \pm 0.5$		1.4	_	

Note: For devices with the ordering part number ending in J(CT.



## **Package Dimensions**

Unit: mm



Weight: 0.01 g (typ.)

	Package Name(s)
JEDEC: SOT-765	
Nickname: US8	



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